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April 1999

# FDN359AN N-Channel Logic Level PowerTrench™ MOSFET

## **General Description**

This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

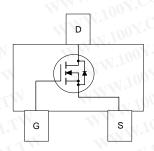
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

#### **Features**

- Very fast switching.
- Low gate charge (5nC typical).
- High power version of industry standard SOT-23 package. Identical pin out to SOT-23 with 30% higher power handling capability.







## **Absolute Maximum Ratings** $T_A = 25^{\circ}\text{C}$ unless other wise noted

Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage	ON 30	V
$V_{GSS}$	Gate-Source Voltage	±20	V
I <sub>D</sub>	Maximum Drain Current - Continuous (Note 1a)	2.7	A
	- Pulsed	WW 15 TW WY	
P <sub>D</sub>	Maximum Power Dissipation (Note 1a)	WWW. C0.5	W
	(Note 1b)	0.46	
$\Gamma_{J}$ , $T_{STG}$	Operating and Storage Temperature Range	-55 to 150	
THERMA	L CHARACTERISTICS	W. 1003. COM. T.	1
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	250	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case (Note 1)	75	°C/W

Electrical Characteristics (T <sub>A</sub> = 25 °C unless otherwise noted )							
Symbol	Parameter	Conditions	Min	Тур	Max	Units	
OFF CHARACTERISTICS							
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	30			V	
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25 °C	W	23		mV/°C	
	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \ V_{GS} = 0 \text{ V}$ $T_{J} = 55^{\circ}\text{C}$	- TIN		1	μA	
					10	μA	
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	1.1		100	nA	
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	$\Lambda$ .T		-100	nA	
ON CHARACTERISTICS (Note)							
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	P1,	1.6	3	V	
$\Delta V_{GS(th)}/\Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25 °C	ON	-4		mV/°C	
R <sub>DS(ON)</sub>		$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$ $T_J = 125^{\circ}\text{C}$	COI	0.037	0.046	Ω	
003.00				0.055	0.075		
		$V_{GS} = 4.5 \text{ V}, I_D = 2.4 \text{ A}$	1.0	0.049	0.06		
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V}, \ V_{DS} = 5 \text{ V}$	15			Α	
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 2.7 \text{ A}$	.Va	9.5	TW	S	
DYNAMIC CHARACTERISTICS							
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$	700.	480	1.1	pF	
C <sub>oss</sub>	Output Capacitance		1.100	120	$M^{T}$	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance		-110	45	_113	pF	
SWITCHING CHARACTERISTICS (Note)							
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 5 \text{ V}, \ I_{D} = 1 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \ R_{GEN} = 6 \Omega$	W.7	6	12	ns	
ţ	Turn - On Rise Time		o W	13	24	ns	
t <sub>D(off)</sub>	Turn - Off Delay Time			15	27	ns	
t,	Turn - Off Fall Time			4	10	ns	
$Q_g$	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_{D} = 2.7 \text{ A},$ $V_{GS} = 5 \text{ V}$	WW	5	7	nC	
$Q_{gs}$	Gate-Source Charge		W.V	1.4	ov C	nC	
$Q_{gd}$	Gate-Drain Charge	W.100 COM.		1.6	UV -	nC	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
l <sub>s</sub>	Maximum Continuous Drain-Source Diode Fo	1110		N.	0.42	Α	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 0.42 \text{ A} \text{ (Note)}$		0.65	1.2	V	

Typical  $R_{_{\theta JA}}$  using the board layouts shown below on FR-4 PCB in a still air environment :



a. 250°C/W when mounted on 1 0.02 in² pad of 2oz Cu a 0.02 in<sup>2</sup> pad of 2oz Cu.



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ed c . vil .. pad. WWW.100Y.COM.TW b. 270°C/W when mounted on a minimum pad. WWW.100Y.COM.TW

2. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%. WWW.100Y.COM.TW WWW.100Y.COM.TW

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<sup>1.</sup> R<sub>BLA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BL</sub> is guaranteed by design while R<sub>eca</sub> is determined by the user's board design. WWW.100Y.

# **Typical Electrical Characteristics**

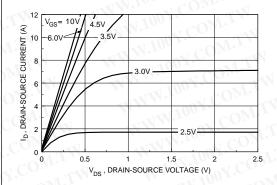


Figure 1. On-Region Characteristics.

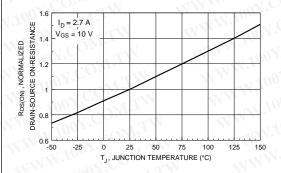


Figure 3. On-Resistance Variation with Temperature.

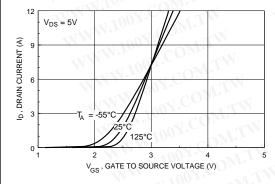


Figure 5. Transfer Characteristics.

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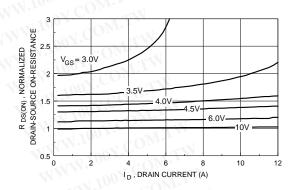


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

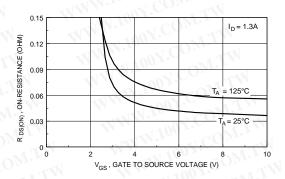


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

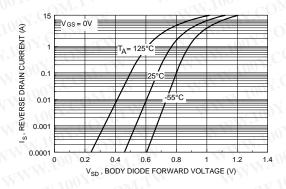


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

## **Typical Electrical Characteristics**

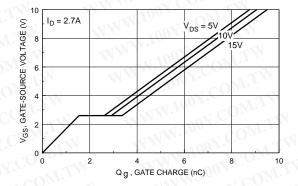


Figure 7. Gate Charge Characteristics.

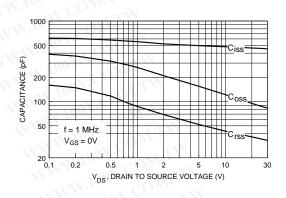


Figure 8. Capacitance Characteristics.

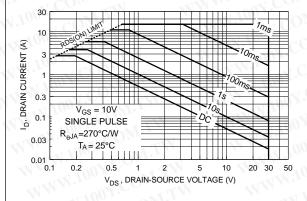


Figure 9. Maximum Safe Operating Area.

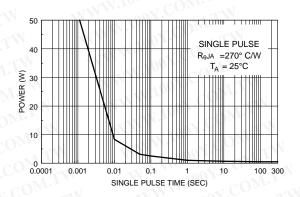


Figure 10. Single Pulse Maximum Power Dissipation.

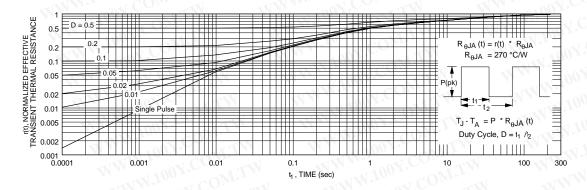


Figure 11. Transient Thermal Response Curve.

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Thermal characterization performed using the conditions described in note 1b.

Transient thermal response will change depending on the circuit board design.

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